Enhancement of Ionization Efficiency of Acceptors by Their Excited States in Heavily Doped Wide Bandgap Semiconductors

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1. Introduction

GaN, SiC and diamond have been attractive wide bandgap semiconductors for devices operating at high powers, high frequencies, and high temperatures. In ptype cases, their acceptor energy level (ΔE_{A}) are reported to be rather deep. According to the hydrogenic model, a ground state level corresponding to the theoretical ΔE_A of a substitutional acceptor in them is expected to be deep because of their dielectric constant lower than Si as well as their hole effective mass heavier than their electron effective mass. For example, $\Delta E_{\rm A}$ for SiC is calculated as 146 meV, and the first excited state level (ΔE_2) is estimated to be 36 meV that is close to ΔE_A of B in Si. Therefore, the excited states should affect the temperature dependence of the hole concentration p(T) in p-type wide bandgap semiconductors.

In this article, a distribution function suitable for acceptors in heavily doped p-type SiC and GaN is investigated using p(T) obtained by Hall-effect measurements. Since the Fermi levels in heavily doped samples are located between the valence band and the acceptor level, which indicates that the Fermi level is close to the excited state levels, there are a lot of holes at the excited states of acceptors. This suggests that a distribution function for acceptors should include the influence of the excited states of acceptors. Therefore, we here consider two distribution functions; (1) the Fermi-Dirac distribution function $f_{\rm FD}(\Delta E_{\rm A})$ not including it and (2) our proposed distribution function $f(\Delta E_{\rm A})$ including it [1-4].

2. Distribution function

$$f_{\rm FD}(\Delta E_{\rm A}) \text{ is described as} f_{\rm FD}(\Delta E_{\rm A}) = \frac{1}{1 + g_{\rm A} \exp\left(\frac{\Delta E_{\rm A} - \Delta E_{\rm F}(T)}{kT}\right)}, \qquad (1)$$

where $\Delta E_{\rm F}(T)$ is the Fermi level measured from the valence band maximum ($E_{\rm V}$), $g_{\rm A}$ is the acceptor degeneracy factor of 4, k is the Boltzmann constant, and T is the absolute temperature.

On the other hand, the distribution function considering the influence of the excited states of acceptors is given by [1-4]

$$f(\Delta E_{\rm A}) = \frac{1}{1 + g_{\rm A}(T) \exp\left(\frac{\Delta E_{\rm A} - \Delta E_{\rm F}(T)}{kT}\right)},$$
 (2)

where

$$g_{A}(T) = g_{A}\left[1 + \sum_{r=2}^{\infty} g_{r} \exp\left(\frac{\Delta E_{r} - \Delta E_{A}}{kT}\right)\right] \exp\left(-\frac{\overline{E_{ex}(T)}}{kT}\right)$$
(3)

 g_r is the (r-1) th excited state degeneracy factor of r^2 , ΔE_r is the difference in energy between E_V and the excited state level $[\Delta E_r = 13.6m_h^*/(m_0\varepsilon_s^2r^2)]$ eV], $E_{ex}(T)$ is an ensemble average energy of the acceptor and excited state levels, given by [1-4]

$$\overline{E_{\text{ex}}(T)} = \frac{\sum_{r=2}^{\infty} (\Delta E_{\text{A}} - \Delta E_{r}) g_{r} \exp\left(-\frac{\Delta E_{\text{A}} - \Delta E_{r}}{kT}\right)}{1 + \sum_{r=2}^{\infty} g_{r} \exp\left(-\frac{\Delta E_{\text{A}} - \Delta E_{r}}{kT}\right)}, (4)$$

 m_0 is the free space electron mass, m_h^* is the hole effective mass, and ε_s is the dielectric constant.

3. Free carrier concentration spectroscopy

Free carrier concentration spectroscopy (FCCS) is a graphical peak analysis method for determining the acceptor density (N_A) and ΔE_A from p(T) using any distribution function. Using an experimental p(T), the FCCS signal is defined as [1-4]

$$H(T, E_{\rm ref}) \equiv \frac{p(T)^2}{(kT)^{5/2}} \exp\left(\frac{E_{\rm ref}}{kT}\right),\tag{5}$$

where E_{ref} is the parameter that can shift the peak temperature within the measurement temperature range. On the other hand, the FCCS signal is theoretically described as [1-4]

$$H(T, E_{\rm ref}) = \frac{N_{\rm A}}{kT} \exp\left(-\frac{\Delta E_{\rm A} - E_{\rm ref}}{kT}\right) I(\Delta E_{\rm A}) - \frac{N_{\rm D} N_{\rm V0}}{kT} \exp\left(\frac{E_{\rm ref} - \Delta E_{\rm F}(T)}{kT}\right)$$
(6)

where

$$I(\Delta E_{\rm A}) = N_{\rm V0} \exp\left(\frac{\Delta E_{\rm A} - \Delta E_{\rm F}(T)}{kT}\right) F(\Delta E_{\rm A}), \qquad (7)$$

$$F(\Delta E_{\rm A})$$
 represents $f_{\rm FD}(\Delta E_{\rm A})$ or $f(\Delta E_{\rm A})$, $N_{\rm D}$ is

the total donor density, $N_{\rm V0} = 2(2\pi m_{\rm h}^* / h^2)^{3/2}$, and *h* is Planck's constant.

Since the FCCS signal has a peak at the temperature corresponding to ΔE_A , the values of N_A and ΔE_A can be determined from the peak.

4. Experiment

A 400- μ m-thick Al-doped 6H-SiC wafer with a resistivity of 1.4 Ω cm and a 2- μ m-thick Mg-doped GaN epilayer on undoped GaN/sapphire were used. The p(T) was obtained by Hall-effect measurements in a magnetic field of 1.4 T.

5. Results and discussion

Figure 1 shows p(T) for Al-doped 6H-SiC (circles) and Mg-doped GaN (triangles). Using these p(T), the FCCS signals are calculated using Eq. (5).

Figure 2 depicts $H(T, E_{ref})$ with $E_{ref} = 0.248$ eV for Al-doped 6H-SiC. From the peak of the FCCS signal, N_A , ΔE_A and N_D are determined as 2.5×10^{19} cm⁻³, 180 meV and 7.3×10^{17} cm⁻³ for $f_{FD}(\Delta E_A)$, and 3.2×10^{18} cm⁻³, 180 meV and 9.0×10^{16} cm⁻³ for $f(\Delta E_A)$, respectively. The broken and solid lines in Fig. 2 represent the $H(T, E_{ref})$ simulations for $f_{FD}(\Delta E_A)$ and $f(\Delta E_A)$ using Eq. (6). The solid line is in better agreement with the circles than the other, indicating that the excited states affect p(T) obviously. Moreover, since $N_A - N_D$ determined by capacitance-voltage characteristics was 4.2×10^{18} cm⁻³, the values determined using $f(\Delta E_A)$.

From the peak of the FCCS signal for Mg-doped GaN, N_A , ΔE_A and N_D are determined as 2.1×10^{20} cm⁻³, 154 meV and 2.2×10^{18} cm⁻³ for $f_{\rm FD}(\Delta E_A)$, and 8.9×10^{18} cm⁻³, 149 meV and 1.5×10^{17} cm⁻³ for $f(\Delta E_A)$, respectively. Since the Mg concentration determined by secondary ion mass spectroscopy was 2×10^{19} cm⁻³, the values obtained using $f(\Delta E_A)$ are more reasonable than the other.

Figure 3 shows the p(T) simulations with $N_{\rm A} = 3.2 \times 10^{18}$ cm⁻³, $\Delta E_{\rm A} = 180$ meV and $N_{\rm D} = 9.0 \times 10^{16}$ cm⁻³ using $f_{\rm FD}(\Delta E_{\rm A})$ (broken line) and $f(\Delta E_{\rm A})$ (solid line). At high temperatures, the broken line is much lower than the experimental p(T). The situation in Mg-doped GaN is the same. These results demonstrate that the excited states enhance the ionization efficiency of acceptors.

6. Conclusion

The p(T) for heavily Al-doped 6H-SiC and Mgdoped GaN were investigated. Since the acceptor levels in them are rather deep, the distribution function including the influence of the excited states of acceptors was required to analyze p(T). From the discussion, it is proved that the excited states of acceptors enhance the ionization efficiency of acceptors.

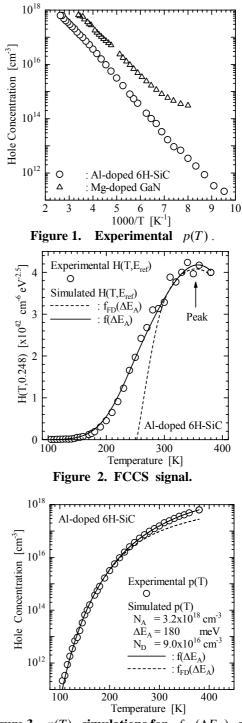


Figure 3. p(T) simulations for $f_{\rm FD}(\Delta E_{\rm A})$ and $f(\Delta E_{\rm A})$ with the same values.

References

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